

Tflex 300 Series Thermal Gap Filler



*Ready for 5G

Product Description

Tflex™ 300, at pressures of 50psi, will deflect to over 50% the original thickness. This high rate of compliancy allows the material to "totally blanket" the component, enhancing thermal transfer. The material has a very low compression set enabling the pad to be reused many times.

Tflex™ 300, in achieving its stellar compliancy, does not sacrifice thermal performance. With a thermal conductivity of 1.2 W/mK, low thermal resistances can be achieved at low pressures.

Tflex™ 300H is offered with a hard, metallized liner option for easy handling and improved rework. The metallized liner's lower coefficient of friction also allows for easy assembly of parts that must slide together, such as a card into a chassis.

Tflex™ 300TG is offered with a cut-through resistant Tgard™ silicone liner. The TG liner offers a guaranteed dielectric barrier, and easier part handling for mass production.

FEATURES AND BENEFITS

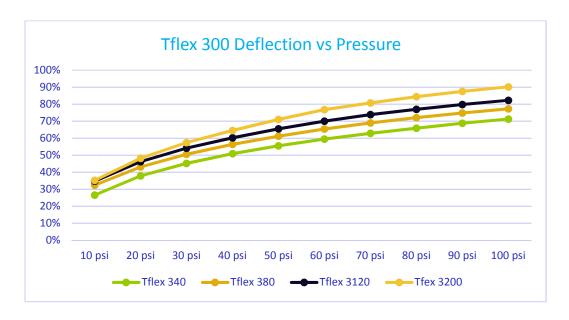
- Extreme compliancy allows material to "totally blanket" components
- Thermal conductivity of 1.2 W/mK
- Low compression set enables the pad to be reused many times
- Environmentally friendly solution that meets regulatory requirements including RoHS and REACH

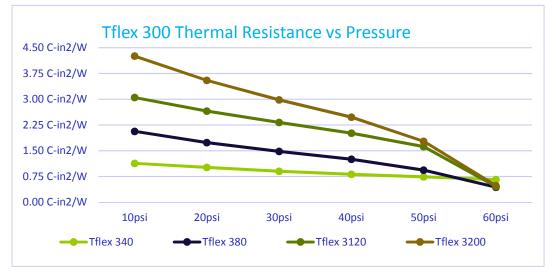
SPECIFICATIONS

TYPICAL PROPERTIES	VALUE	TEST METHOD
Construction & Composition	Ceramic filled silicone sheet	N/A
Color	Light Green	Visual
Thickness Range	0.50mm (0.020") - 5.08mm (0.20")	N/A
Thermal Conductivity (W/mK)	1.2	ASTM D5470
Density (g/cc)	1.78	Helium Pyncometer
Hardness (Shore 00)	51.4 (20-30 mil)	ASTM D2240
	25.2 (40+ mil)	
Outgassing TML (weight %)	0.56	ASTM E595
Outgassing CVCM (weight %)	0.1	ASTM E595
Temperature Range	-40°C to 160°C	N/A
Rth@ 40 mils, 10 psi, 50°C	0.98°C-in2/W	ASTM D5470
		(modified)
* Dielectric Constant @ 10GHz	4.5 *	ASTM D150
UL Flammability Rating	V-0	UL 94
Volume Resistivity	10^13 ohm-cm	ASTM D257



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AVAILABILITY

STANDARD THICKNESSES

- 0.5mm (0.020") to 5.0mm (0.200") thick material available in 0.25mm (0.010") increments
- Available in standard sheet sizes of 18" x 18" and 9" x 9" or custom die cut parts

OPTIONS

- DC1 proprietary tack eliminated coating
- Tgard "TG" dielectric barrier available to aid in handling and PET dielectric "H" liner available for applications for easy slide assembly

PART NUMBER SYSTEM

Tflex™ indicates Laird elastomeric thermal gap filler product line. 3xxx indicates Tflex 300 product line with thickness in mils (0.001") EXAMPLES:

- Tflex™ 340 = 0.040 inch thick Tflex™ 300 material
- Tflex™ 380DC1 = 0.080 inch thick Tflex™ 300 material with DC1 coating
- Tflex™ 3120TG = 0.120 inch thick Tflex™ 300 material with Tgard™ liner
- Tflex™ 3200H = 0.200 inch thick Tflex™ 300 material with hard PET liner

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